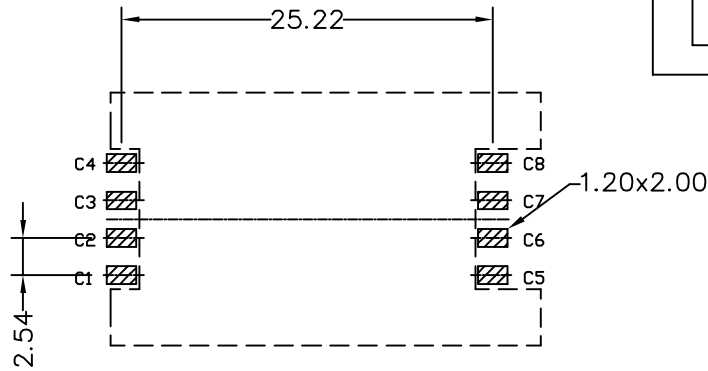
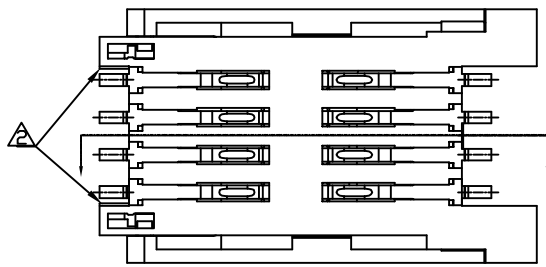
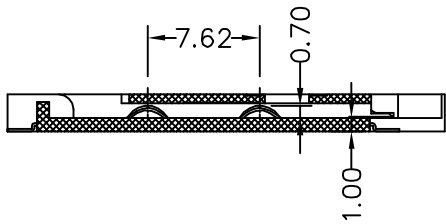
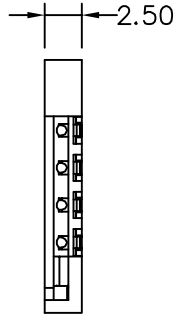
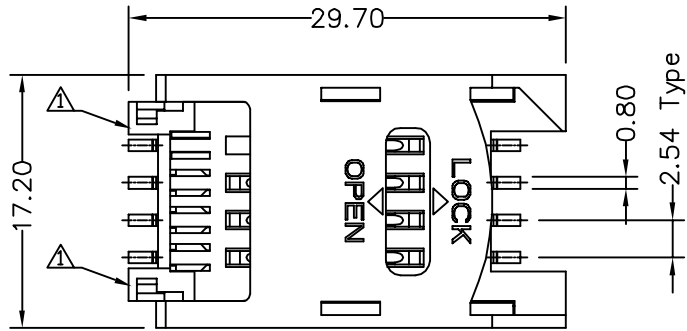


**SPECIFICATIONS**

Housing: Thermoplastic (UL94 V-0)  
 Terminal: Phosphor Bronze, Gold Plating On Contact Area,  
 Tin Plating On Solder Tail.  
 Current Rating: 0.5A Max.  
 Dielectric Withstanding Voltage: 500V AC R.M.S. For 1 Minute  
 Insulation Resistance: 1000 Megohms Min. At DC 500V  
 Contact Resistance: 50 milliohms Max.  
 Durability: 5000 Cycles  
 Manual Soldering: 360°C, 3Sec Max.  
 Vapor Phase: 215°C, 30Sec Max.  
 IR Reflow: 260°C, 15Sec Max.  
 Operation Temperature: -25°C To +85°C  
 RoHS Compliant  
 Part No:

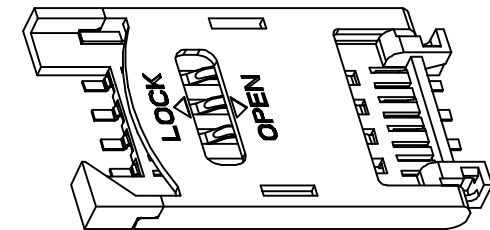
SC V - W 08 A 25 - 020 C - H

- RoHS Compliant
- Without Peg & Switch
- Selective Gold(Gold Flash)
- Base Height, 2.5mm
- Row Pitch, 25.22mm
- No. Of Pins, 8pins
- SMT Type
- Hinged Cover
- Smart Card/Sim Card



(.XX±0.05)

REFERENCE PCB LAYOUT



CATEGORY Smart Card/Sim Card		APPROVED BY MEI		UNLESS OTHERWISE SPECIFIED	
PART No. SCV-W08A25-020C-H		CHECKED BY SHIN		TOLERANCES ARE	
DRAWING No. SCV-W08A25-020C-H		DRAWING BY XSH 01/08-2008		.X ±0.38	
SCALE NONE		REV. A2		.XX ±0.25	
				ANG. ±1°	
				UNIT mm	

A2		ADD CHAMFER		XSH 01/08-2008	
A1		MODIFIED AXES		XSH 09/27-2007	
A0		NEW RELEASE		XSH 08/31-2005	
NO. REV.		REVISIONS		CHK DATE	